

# SCT4062KW7HR

# **Automotive Grade N-channel SiC power MOSFET**

Datasheet

| $V_{DSS}$                  | 1200V |
|----------------------------|-------|
| R <sub>DS(on)</sub> (Typ.) | 62mΩ  |
| I <sub>D</sub> *1          | 24A   |
| $P_D$                      | 93W   |

# Outline TO-263-7L

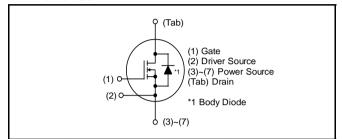
#### Features

- 1) Qualified to AEC-Q101
- 2) Low on-resistance
- 3) Fast switching speed
- 4) Fast reverse recovery
- 5) Easy to parallel
- 6) Simple to drive
- 7) Pb-free lead plating; RoHS compliant

# Application

- Automobile
- Switch mode power supplies

#### ●Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

# Packaging specifications

|      | Packing                   | Embossed tape |
|------|---------------------------|---------------|
|      | Reel size (mm)            | 330           |
| Typo | Tape width (mm)           | 24            |
| Type | Basic ordering unit (pcs) | 1000          |
|      | Taping code               | TL            |
|      | Marking                   | SCT4062KW7    |

# ● **Absolute maximum ratings** (T<sub>vi</sub> = 25°C unless otherwise specified.)

| Parameter  |                                      | Symbol                     | Value                              | Unit       |   |
|--|--------------------------------------|----------------------------|------------------------------------|------------|---|
| Drain - source voltage                                   |                                      | $V_{DSS}$                  | 1200                               | V          |   |
| Continuous drain   | $V_{GS} = V_{GS\_on}$                | $T_c = 25^{\circ}C$        | I <sub>D</sub> , I <sub>S</sub> *1 | 24         | А |
| and source current                                       | V <sub>GS</sub> = V <sub>GS_on</sub> | T <sub>c</sub> = 100°C     | I <sub>D</sub> , I <sub>S</sub>    | 17         | А |
| Pulsed drain current                                     | $V_{GS} = V_{GS\_on}$                | $T_c = 25^{\circ}C$        | I <sub>D,pulse</sub> *2            | 52         | А |
| Body diode pulsed forward                                | ard current                          | $T_c = 25^{\circ}C$        | I <sub>S,pulse</sub> *1,*3         | 24         | А |
| Body diode surge forward current $V_{GS} = 0 \text{ V}$  |                                      | I <sub>S,pulse</sub> *1,*4 | 52                                 | А          |   |
| Gate - source voltage (DC)                               |                                      | $V_{GSS\_DC}$              | -4 to +21                          | V          |   |
| Gate - source surge voltage (t <sub>surge</sub> < 300ns) |                                      | V <sub>GSS_surge</sub> *5  | -4 to +23                          | V          |   |
| Recommended turn-on gate - source drive voltage          |                                      | ive voltage                | ${\sf V_{GS\_on}}^{*6}$            | +15 to +18 | V |
| Recommended turn-off gate - source drive voltage         |                                      | $V_{GS\_off}$              | 0                                  | V          |   |
| Virtual junction temperature                             |                                      | T <sub>vj</sub>            | 175                                | °C         |   |
| Range of storage temperature                             |                                      | $T_{stg}$                  | -40 to +175                        | °C         |   |

# ullet Electrical characteristics (T<sub>vj</sub> = 25°C unless otherwise specified)

| Doromotor                                   | Cymbol                 | Conditions                                     | Conditions |      | Values |           |  |
|---|------------------------|--|------------|------|--------|-----------|--|
| Parameter                                   | Symbol                 | Conditions                                     | Min.       | Тур. | Max.   | Unit      |  |
| Drain - Source breakdown                    | W                      | $V_{GS} = 0 \text{ V}, I_D = 5.3\text{mA}$     |            |      |        | V         |  |
| voltage                                     | V (BR)DSS              | $T_{vj} = 25^{\circ}C$                         | 1200       | -    | -      | V         |  |
|   |                        | $V_{GS} = 0 \text{ V}, V_{DS} = 1200 \text{V}$ |            |      |        |           |  |
| Zero Gate voltage Drain current             | I <sub>DSS</sub>       | $T_{vj} = 25^{\circ}C$                         | -          | 1    | 80     | μA        |  |
| Diam ourion                                 |                        | T <sub>vj</sub> = 150°C                        | -          | 10   | -      |           |  |
| Gate - Source leakage current               | I <sub>GSS+</sub>      | $V_{GS} = +21V , V_{DS} = 0V$                  | -          | -    | 100    | nA        |  |
| Gate - Source leakage current               | I <sub>GSS-</sub>      | $V_{GS} = -4V$ , $V_{DS} = 0V$                 | -          | -    | -100   | nA        |  |
| Gate threshold voltage                      | $V_{GS(th)}^{*7}$      | $V_{DS} = 10V, I_{D} = 6.45 \text{mA}$         | 2.8        | -    | 4.8    | V         |  |
|   |                        | $V_{GS} = 18V, I_{D} = 12A$                    |            |      |        |           |  |
| Static Drain - Source on - state resistance | R <sub>DS(on)</sub> *8 | $T_{vj} = 25^{\circ}C$                         | -          | 62   | 81     | $m\Omega$ |  |
| 5 515.15 155.5 <b>16</b> .1100              |                        | T <sub>vj</sub> = 150°C                        | -          | 124  | -      |           |  |
| Gate input resistance                       | $R_{G}$                | f = 1MHz, open drain                           | -          | 4    | -      | Ω         |  |

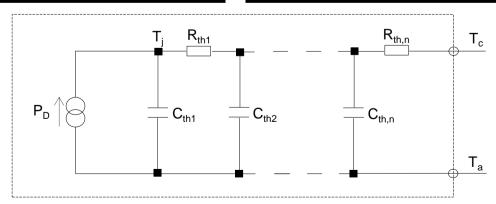
# ●Thermal resistance

| Parameter                           | Symbol               | Values |      |      | Unit  |
|-------------------------------------|----------------------|--------|------|------|-------|
| Falametei                           |                      | Min.   | Тур. | Max. | Offic |
| Thermal resistance, junction - case | R <sub>thJC</sub> *9 | -      | 1.2  | 1.6  | K/W   |

●Typical Transient Thermal Characteristics

| Symbol           | Value                         | Unit |
|------------------|-------------------------------|------|
| R <sub>th1</sub> | 8.9 <b>×</b> 10 <sup>-2</sup> |      |
| R <sub>th2</sub> | 5.7 ×10 <sup>-1</sup>         | K/W  |
| R <sub>th3</sub> | 5.3 ×10 <sup>-1</sup>         |      |

| Symbol           | Value                         | Unit |
|------------------|-------------------------------|------|
| C <sub>th1</sub> | 5.3 ×10 <sup>-4</sup>         |      |
| $C_{th2}$        | 2.8 <b>×</b> 10 <sup>-3</sup> | Ws/K |
| C <sub>th3</sub> | 1.5 ×10 <sup>-1</sup>         |      |



# ullet Electrical characteristics (T<sub>vj</sub> = 25°C unless otherwise specified)

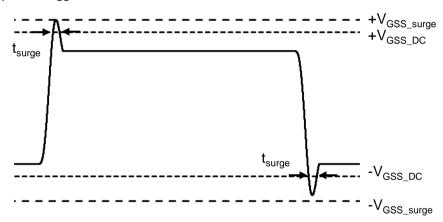
| Dovomotov                                    | Cumple of              | Canditions  |      | Values |      |      |
|--|------------------------|---|------|--------|------|------|
| Parameter                                    | Symbol                 | Conditions  | Min. | Тур.   | Max. | Unit |
| Transconductance                             | g <sub>fs</sub> *8     | $V_{DS} = 10V, I_{D} = 12A$   | -    | 6.5    | -    | S    |
| Input capacitance                            | C <sub>iss</sub>       | V <sub>GS</sub> = 0V  | -    | 1498   | -    |      |
| Output capacitance                           | C <sub>oss</sub>       | V <sub>DS</sub> = 800V  | -    | 45     | -    | pF   |
| Reverse transfer capacitance                 | C <sub>rss</sub>       | f = 1MHz  | -    | 3      | -    | ,    |
| Effective output capacitance, energy related | C <sub>o(er)</sub>     | $V_{GS} = 0V$<br>$V_{DS} = 0V \text{ to } 800V$                         | -    | 54     | -    | pF   |
| Total Gate charge                            | Q <sub>g</sub> *8      | $V_{DS} = 800V$ $I_{D} = 12A$   | -    | 64     | -    |      |
| Gate - Source charge                         | Q <sub>gs</sub> *8     | $V_{GS} = 18V$  | -    | 14     | -    | nC   |
| Gate - Drain charge                          | Q <sub>gd</sub> *8     | See Fig. 1-1, 1-2.  | -    | 17     | -    |      |
| Turn - on delay time                         | t <sub>d(on)</sub> *8  | $V_{DS} = 800V$ $I_{D} = 12A$   | -    | 4.4    | •    |      |
| Rise time                                    | t <sub>r</sub> *8      | $V_{GS} = +18V / 0V$  | -    | 11     | -    | ns   |
| Turn - off delay time                        | t <sub>d(off)</sub> *8 | $R_G = 0\Omega$ , L = 250 $\mu$ H<br>$E_{on}$ includes diode            | -    | 22     | -    | 113  |
| Fall time                                    | t <sub>f</sub> *8      | reverse recovery $L_{\sigma} = 50 \text{nH}, C_{\sigma} = 10 \text{pF}$ | -    | 10     | -    |      |
| Turn - on switching loss                     | E <sub>on</sub> *8     | See Fig. 2-1, 2-2, 2-3.   | -    | 132    | -    | μJ   |
| Turn - off switching loss                    | E <sub>off</sub> *8    |   | -    | 6      | -    | μο   |
| $V_{GS(on)} = +15V$<br>Short-circuit         | - t <sub>sc</sub> *9   | $V_{DS} \le 800V$ $V_{DS,peak} \le 1200V$                               | -    | 4.5    | -    | μs   |
| withstand time $V_{GS(on)} = +18V$           |                        | $T_{vj(start)} = 25^{\circ}C$<br>$R_G = 2.2\Omega$                      | -    | 4.0    | -    | μs   |

# ●Body diode electrical characteristics (Source-Drain) (T<sub>vi</sub> = 25°C unless otherwise specified)

| Parameter                     | Symbol Conditions - |  | Values |      |      | Unit  |
|-------------------------------|---------------------|--|--------|------|------|-------|
| - raiailletei                 | Symbol              | Conditions   | Min.   | Тур. | Max. | Offic |
| Forward voltage               | V <sub>SD</sub> *8  | $V_{GS} = 0V, I_{S} = 12A$                                       | ı      | 3.3  | ı    | V     |
| Reverse recovery time         | t <sub>rr</sub> *8  | $I_F = 12A$ $V_R = 800V$   | ı      | 8.1  | ı    | ns    |
| Reverse recovery charge       | Q <sub>rr</sub> *8  | $di/dt = 3800A/\mu s$  | -      | 105  | -    | nC    |
| Peak reverse recovery current | I <sub>rrm</sub> *8 | $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF<br>See Fig. 3-1, 3-2. | -      | 26   | -    | А     |

<sup>\*1</sup> Limited by maximum  $T_{vj}$  and for Max.  $R_{thJC}$ .

# \*5 Example of acceptable V<sub>GS</sub> waveform



Please note especially when using driver source that V<sub>GSS\_surge</sub> must be in the range of absolute maximum rating.

- \*6 Please be advised not to use SiC-MOSFETs with V<sub>GS</sub> below 10V as doing so may cause thermal runaway.
- \*7 Tested after applying  $V_{GS} = 21V$  for 100ms.
- \*8 Pulsed
- \*9 The value is based on TO-247 package. Single Pulsed.
- \*10 Measured conformable to JESD51-14.

See the application note "rthjc\_measurement\_and\_usage\_an-e.pdf". Link

URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc\_measurement\_and\_usage\_an-e.pdf

<sup>\*2</sup> Pulse width and duty cycle are limited by T<sub>vj,max</sub>.

<sup>\*3</sup> Only for body-diode, Repititive pulse, PW ≤ 1.5µs, Duty cycle ≤ 5%

<sup>\*4</sup> When used as a protective function, PW ≤ 10µs

Fig.1 Power Dissipation Derating Curve

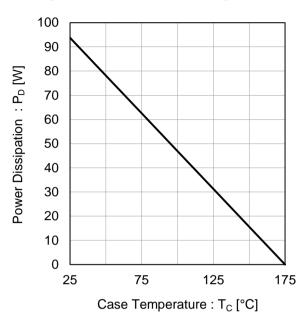


Fig.2 Maximum Safe Operating Area

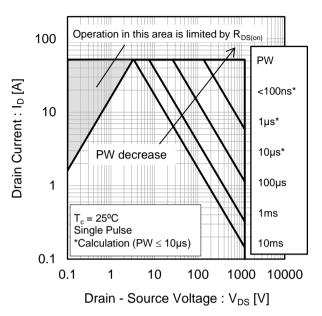
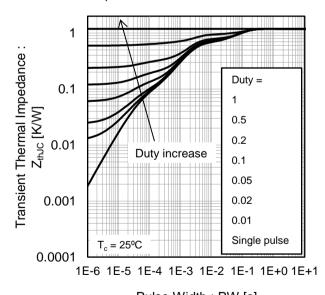


Fig.3 Typical Transient Thermal Impedance vs. Pulse Width



Pulse Width: PW [s]

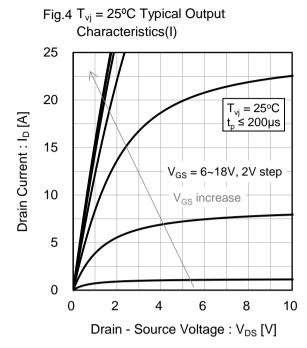
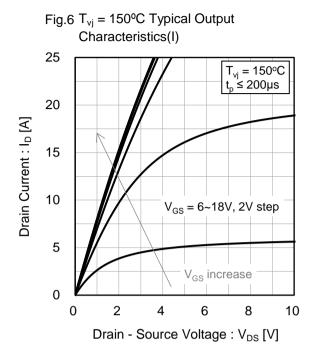
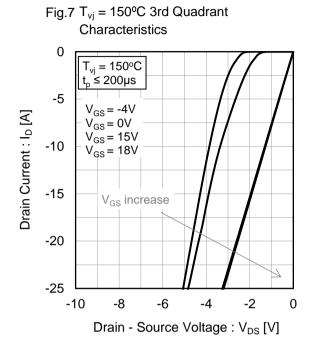


Fig.5  $T_{vj} = 25^{\circ}\text{C}$  3rd Quadrant Characteristics  $\begin{array}{c} 0 \\ \hline T_{vj} = 25^{\circ}\text{C} \\ \hline t_{p} \leq 200 \mu \text{s} \\ \hline V_{GS} = -4 V \\ V_{GS} = 0 V \\ \hline V_{GS} = 15 V \\ V_{GS} = 18 V \\ \hline \end{array}$  -10  $V_{GS} = 18 V$  -25  $V_{GS} = 10 \times 10^{\circ}$  -20  $V_{GS} = 10^{\circ}$ 

Drain - Source Voltage : V<sub>DS</sub> [V]

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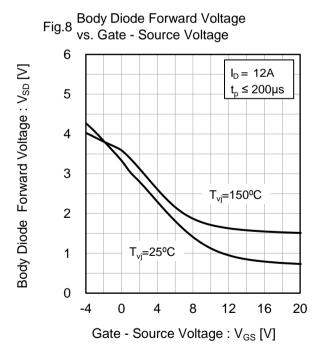


Fig.9 Typical Transfer Characteristics (I)

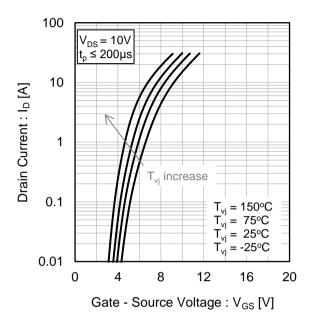


Fig.10 Typical Transfer Characteristics (II)

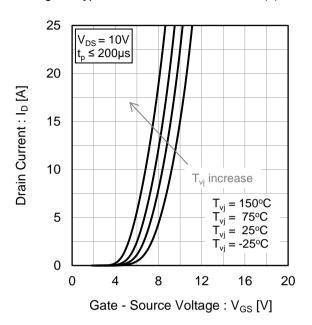


Fig.11 Gate Threshold Voltage vs. Virtual Junction Temperature

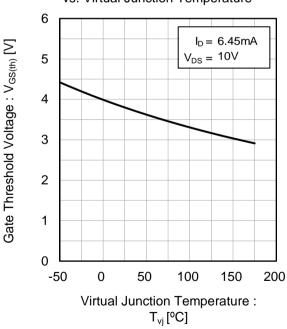


Fig.12 Transconductance vs. Drain Current

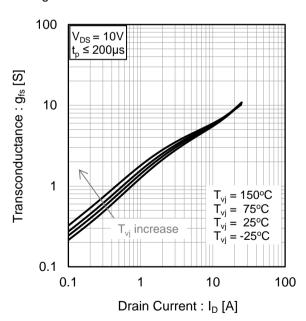


Fig.13 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

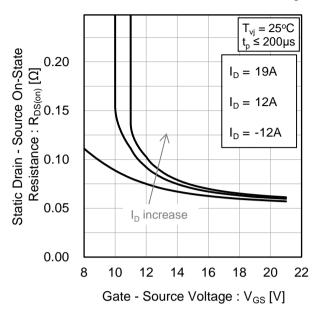


Fig.14 Static Drain - Source On - State Resistance vs. Virtual Junction Temperature

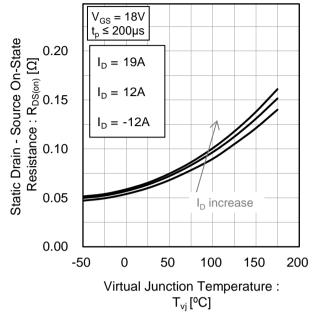


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current

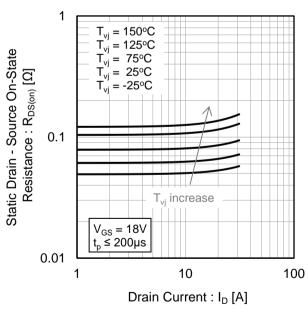
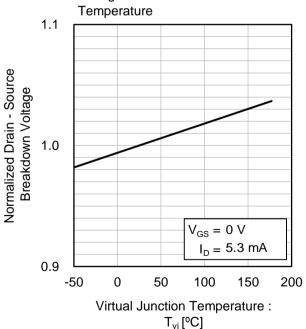
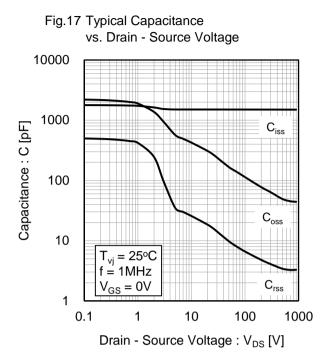


Fig.16 Normalized Drain - Source Breakdown Voltage vs. Virtual Junction





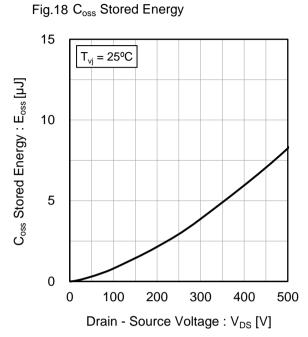


Fig.19 Dynamic Input Characteristics

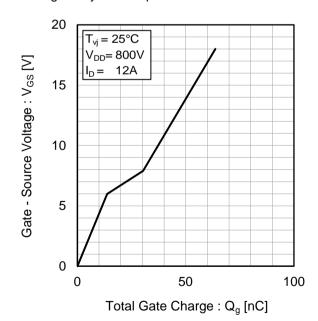


Fig.20 Typical Switching Time vs. External Gate Resistance 80  $T_{vi} = 25^{\circ}C$ 12A  $t_{d(off)}$ V<sub>DD</sub>= 800V 60 V<sub>GS</sub>= +18V/0V Switching Time : t [ns]  $L = 250 \mu H$ 40  $t_{d(on)}$ 20 i t<sub>r</sub> i t<sub>f</sub> 0 5 10 15 20 External Gate Resistance :  $R_G[\Omega]$ 

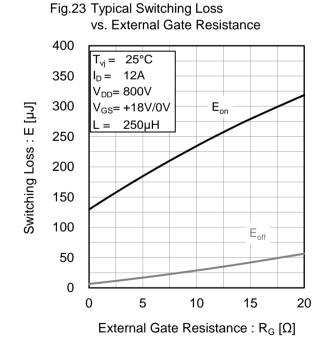
Fig.21 Typical Switching Loss vs. Drain - Source Voltage 400  $T_{vi} = 25^{\circ}C$ 350 12A V<sub>GS</sub>= +18V/0V Switching Loss: E [µJ] 300  $R_G = 0\Omega$  $L = 250 \mu H$ 250 200 150 100 50 0 100 200 300 400 500 600 700 800 Drain - Source Voltage: V<sub>DS</sub> [V]

Fig.22 Typical Switching Loss vs. Drain Current 400 25°C  $V_{DD} = 800V$ 350 V<sub>GS</sub>= +18V/0V 300  $R_G = 0\Omega$ Switching Loss: E [µJ] 250µH L =250 200  $\mathsf{E}_{\mathsf{on}}$ 150 100 50 0 0 5 10 15 20 25 Drain Current: I<sub>D</sub> [A]

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### • Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

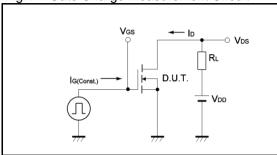


Fig.2-1 Switching Characteristics Measurement Circuit

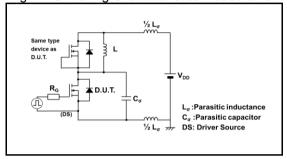


Fig.2-3 Waveforms for Switching Energy Loss

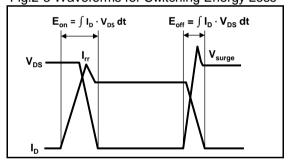


Fig.3-1 Reverse Recovery Time Measurement Circuit

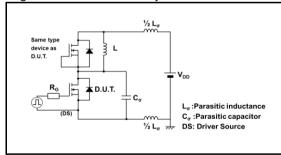


Fig.1-2 Gate Charge Waveform

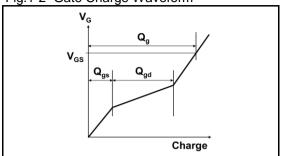


Fig.2-2 Waveforms for Switching Time

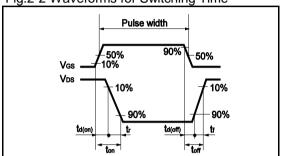
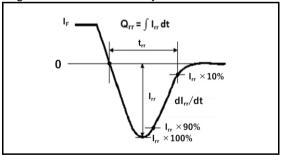
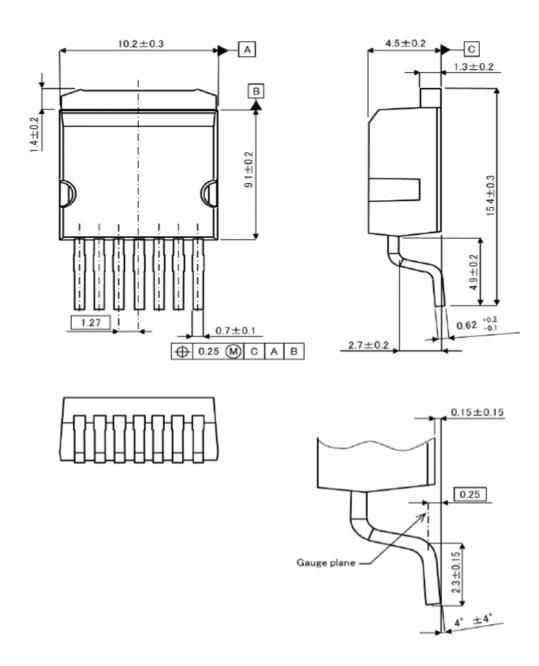


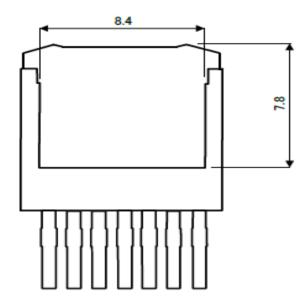
Fig.3-2 Reverse Recovery Waveform



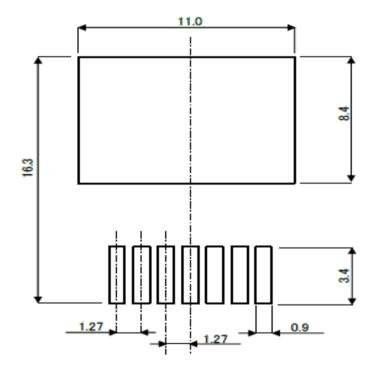
# ●Package Dimensions



Unit: mm



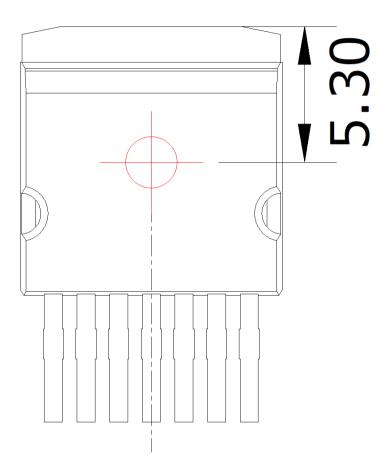
# RECOMMENDED FOOTPRINT DIMENSIONS



Unit: mm

# ●Die Bonding Layout





- •Front view of the packaging.
- •Dimensions are design values.
- ·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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